L	Hits	Search Text	DB	Time stamp
Number				_
1	55412	substrate near3 (ceramic alumina beryllia	USPAT;	2002/10/07
		beo)	US-PGPUB;	16:09
			EPO; JPO;	
			DERWENT	
2	6881	(substrate near3 (ceramic alumina	USPAT;	2002/10/07
		beryllia beo)) and (semiconductor near1	US-PGPUB;	16:11
		(package device))	EPO; JPO;	
		·	DERWENT	
3	328	, , , , , , , , , , , , , , , , , , ,	USPAT;	2002/10/07
		beryllia beo)) and (semiconductor near1	US-PGPUB;	16:12
		(package device))) and (direct\$2 adj	EPO; JPO;	
		(bonded bonding))	DERWENT	
4	430	((substrate near3 (ceramic alumina	USPAT;	2002/10/07
		beryllia beo)) and (semiconductor near1	US-PGPUB;	16:13
		(package device))) and ((encapsulant	EPO; JPO;	
_		sealing) near3 (epoxy resin))	DERWENT	
5	32	(((substrate near3 (ceramic alumina	USPAT;	2002/10/07
		beryllia beo)) and (semiconductor near1	US-PGPUB;	16:13
		(package device))) and (direct\$2 adj	EPO; JPO;	
		(bonded bonding))) and ((encapsulant	DERWENT	
_		sealing) near3 (epoxy resin))		
6	16	(((substrate near3 (ceramic alumina	USPAT;	2002/10/07
		beryllia beo)) and (semiconductor near1	US-PGPUB;	16:16
		(package device))) and ((encapsulant	EPO; JPO;	
		sealing) near3 (epoxy resin))) and ghz	DERWENT	